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SN74LVC16T245 16-BIT DUAL-SUPPLY BUS TRANSCEIVER WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

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FEATURES

- Control Inputs V_{IH}/V_{IL} Levels Are Referenced to V_{CCA} Voltage
- V_{CC} Isolation Feature If Either V_{CC} Input Is at GND, Both Ports Are in the High-Impedance State
- Overvoltage-Tolerant Inputs/Outputs Allow Mixed-Voltage-Mode Data Communications
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.65-V to 5.5-V Power-Supply Range
- I_{off} Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78. Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

DESCRIPTION/ORDERING INFORMATION

This 16-bit noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track V_{CCA} . V_{CCA} accepts any supply voltage from 1.65 V to 5.5 V. The B port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.65 V to 5.5 V. This allows for universal low-voltage bidirectional translation between any of the 1.8-V, 2.5-V, 3.3-V, and 5-V voltage nodes.

DGG OR DGV PACKAGE (TOP VIEW)

				,
4 D.ID [\cup	40	1.5=
1DIR L	1			1 <u>OE</u>
1B1	2			1A1
1B2 L	3] 1A2
GND [4			GND
1B3 [5		44	1A3
1B4 [6] 1A4
V_{CCB}	7			V _{CCA}
1B5 [8		41	1A5
1B6 [9		40] 1A6
GND [10		39	GND
1B7 [11		38] 1A7
1B8 [12		37] 1A8
2B1 [13		36	2A1
2B2 [14		35	2A2
GND [15		34	GND
2B3 [16		33	2A3
2B4 [17		32] 2A4
V_{CCB}	18		31	VCCA
2B5 [19		30	2A5
2B6 [20		29	2A6
GND [21		28	GND
2B7 [22		27	2A7
2B8 [23			2A8
2DIR [24		25	2 0E

The SN74LVC16T245 is designed for asynchronous communication between two data buses. The logic levels of the direction-control (DIR) input and the output-enable (\overline{OE}) input activate either the B-port outputs or the A-port outputs or place both output ports into the high-impedance mode. The device transmits data from the A bus to the B bus when the B-port outputs are activated, and from the B bus to the A bus when the A-port outputs are activated. The input circuitry on both A and B ports is always active and must have a logic HIGH or LOW level applied to prevent excess I_{CC} and I_{CCZ} .

The SN74LVC16T245 is designed so that the control pins (1DIR, 2DIR, 1OE, and 2OE) are supplied by V_{CCA}.

This device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

ORDERING INFORMATION

T _A	PACKAGE ⁽¹)	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	TSSOP – DGG	Tape and reel	SN74LVC16T245DGGR	LVC16T245
400C to 050C	TVSOP - DGV	Tape and reel	SN74LVC16T245DGVR	LDT245
–40°C to 85°C	VFBGA – GQL	Tape and reel	SN74LVC16T245GQLR	LDT245
	VFBGA – ZQL (Pb-free)	Tape and reel	SN74LVC16T245ZQLR	PREVIEW

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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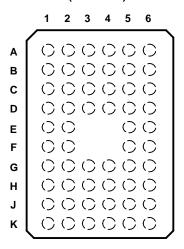
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DESCRIPTION/ORDERING INFORMATION (CONTINUED)

The V_{CC} isolation feature ensures that if either V_{CC} input is at GND, then both ports are in the high-impedance state.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

GQL OR ZQL PACKAGE (TOP VIEW)



TERMINAL ASSIGNMENTS(1)

	1	2	3	4	5	6
Α	1DIR	NC	NC	NC	NC	1 OE
В	1B2	1B1	GND	GND	1A1	1A2
С	1B4	1B3	V_{CCB}	V_{CCA}	1A3	1A4
D	1B6	1B5	GND	GND	1A5	1A6
E	1B8	1B7			1A7	1A8
F	2B1	2B2			2A2	2A1
G	2B3	2B4	GND	GND	2A4	2A3
Н	2B5	2B6	V_{CCB}	V_{CCA}	2A6	2A5
J	2B7	2B8	GND	GND	2A8	2A7
K	2DIR	NC	NC	NC	NC	2 OE

(1) NC - No internal connection

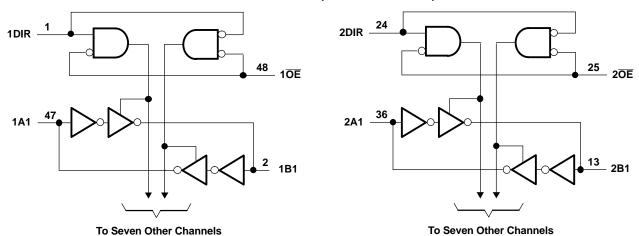
FUNCTION TABLE⁽¹⁾ (EACH 16-BIT SECTION)

CONTRO	L INPUTS	OUTPUT C	IRCUITS	OPERATION
ŌĒ	DIR	A PORT	B PORT	OPERATION
L	L	Enabled	Hi-Z	B data to A bus
L	Н	Hi-Z	Enabled	A data to B bus
Н	Χ	Hi-Z	Hi-Z	Isolation

(1) Input circuits of the data I/Os always are active.

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LOGIC DIAGRAM (POSITIVE LOGIC)



Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
$V_{CCA} V_{CCB}$	Supply voltage range		-0.5	6.5	V
		I/O ports (A port)	-0.5	6.5	
VI	Input voltage range (2)	I/O ports (B port)	-0.5	6.5	V
		Control inputs	-0.5	6.5	
\/	Voltage range applied to any output	A port	-0.5	6.5	V
Vo	in the high-impedance or power-off state (2)	B port	-0.5	6.5	V
\ /	Valence and a second of the se	A port	-0.5 V _{CCA} + 0		V
Vo	Voltage range applied to any output in the high or low state (2)(3)	B port		V _{CCB} + 0.5	V
I _{IK}	Input clamp current	V _I < 0		- 50	mA
I _{OK}	Output clamp current	V _O < 0		- 50	mA
Io	Continuous output current	·		±50	mA
	Continuous current through each V _{CCA} , V _{CCB} , and GND			±100	mA
		DGG package		70	
θ_{JA}	Package thermal impedance (4)	DGV package		58	°C/W
		GQL/ZQL package		28	
T _{stg}	Storage temperature range		-65	150	°C

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

⁽²⁾ The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

⁽³⁾ The output positive-voltage rating may be exceeded up to 6.5 V maximum if the output current rating is observed.

⁽⁴⁾ The package thermal impedance is calculated in accordance with JESD 51-7.



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Recommended Operating Conditions (1)(2)(3)(4)

			V _{CCI}	V _{cco}	MIN	MAX	UNIT
V_{CCA}	Supply voltage				1.65	5.5	V
V_{CCB}	Supply voltage				1.65	5.5	V
			1.65 V to 1.95 V		$V_{CCI} \times 0.65$		
.,	High-level	D-1- ' (5)	2.3 V to 2.7 V		1.7		.,
V_{IH}	input voltage	Data inputs (5)	3 V to 3.6 V		2		V
			4.5 V to 5.5 V		$V_{CCI} \times 0.7$		
			1.65 V to 1.95 V			$V_{CCI} \times 0.35$	
\ /	Low-level	Data innuta (5)	2.3 V to 2.7 V			0.7	V
V_{IL}	input voltage	Data inputs (5)	3 V to 3.6 V			0.8	V
			4.5 V to 5.5 V			$V_{CCI} \times 0.3$	
			1.65 V to 1.95 V		$V_{CCA} \times 0.65$		
.,	High-level	Control inputs	2.3 V to 2.7 V		1.7		.,
V_{IH}	input voltage	(referenced to V _{CCA}) ⁽⁶⁾	3 V to 3.6 V		2		V
			4.5 V to 5.5 V		$V_{CCA} \times 0.7$		
			1.65 V to 1.95 V			$V_{CCA} \times 0.35$	
.,	Low-level	Control inputs	2.3 V to 2.7 V			0.7	.,
V_{IL}	input voltage	(referenced to V _{CCA}) ⁽⁶⁾	3 V to 3.6 V			0.8	V
			4.5 V to 5.5 V			$V_{CCA} \times 0.3$	
VI	Input voltage	Control inputs			0	5.5	V
.,	land the death and the sec	Active state			0	V _{cco}	V
$V_{I/O}$	Input/output voltage	3-State			0	5.5	V
				1.65 V to 1.95 V		-4	
	I limb lavel autout aven			2.3 V to 2.7 V		-8	A
I _{OH}	High-level output curre	ent.		3 V to 3.6 V		-24	mA
				4.5 V to 5.5 V		-32	
				1.65 V to 1.95 V		4	
	Laurianal autout arma			2.3 V to 2.7 V		8	A
I _{OL}	Low-level output curre	nt		3 V to 3.6 V		24	mA
				4.5 V to 5.5 V		32	
			1.65 V to 1.95 V			20	
A 4 / 4	Input transition	Data innuts	2.3 V to 2.7 V			20	01
Δt/Δv	rise or fall rate	Data inputs	3 V to 3.6 V			10	ns/V
			4.5 V to 5.5 V			5	
T _A	Operating free-air tem	perature			-40	85	°C

⁽¹⁾ V_{CCI} is the V_{CC} associated with the data input port. (2) V_{CCO} is the V_{CC} associated with the output port.

All unused or driven (floating) data inputs (I/Os) of the device must be held at logic HIGH or LOW (preferably V_{CCI} or GND) to ensure proper device operation and minimize power. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

 ⁽⁴⁾ All unused data inputs of the device must be held at V_{CCA} or GND to ensure proper device operation.
 (5) For V_{CCI} values not specified in the data sheet, V_{IH} min = V_{CCI} × 0.7 V, V_{IL} max = V_{CCI} × 0.3 V.
 (6) For V_{CCA} values not specified in the data sheet, V_{IH} min = V_{CCA} × 0.7 V, V_{IL} max = V_{CCA} × 0.3 V.



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Electrical Characteristics (1)(2)

over recommended operating free-air temperature range (unless otherwise noted)

DAD	AMETER	TEST CONDITIONS	V	V	$T_A = 25^{\circ}C$	–40°C to 85°C	UNIT
PAR	AMETER	TEST CONDITIONS	V _{CCA}	V _{CCB}	MIN TYP MAX	MIN MAX	UNII
		$I_{OH} = -100 \mu A$, $V_I = V_{IH}$	1.65 V to 4.5 V	1.65 V to 4.5 V		V _{CCO} - 0.1	
		$I_{OH} = -4 \text{ mA}, \qquad V_I = V_{IH}$	1.65 V	1.65 V		1.2	
V_{OH}		$I_{OH} = -8 \text{ mA}, \qquad V_I = V_{IH}$	2.3 V	2.3 V		1.9	V
		$I_{OH} = -24 \text{ mA}, \qquad V_I = V_{IH}$	3 V	3 V		2.4	
		$I_{OH} = -32 \text{ mA}, V_I = V_{IH}$	4.5 V	4.5 V		3.8	
		$I_{OL} = 100 \mu A$, $V_I = V_{IL}$	1.65 V to 4.5 V	1.65 V to 4.5 V		0.1	
		$I_{OL} = 4 \text{ mA}, \qquad V_I = V_{IL}$	1.65 V	1.65 V		0.45	
V_{OL}		$I_{OL} = 8 \text{ mA}, \qquad V_I = V_{IL}$	2.3 V	2.3 V		0.3	V
		$I_{OL} = 24 \text{ mA}, \qquad V_I = V_{IL}$	3 V	3 V		0.55	
		$I_{OL} = 32 \text{ mA}, \qquad V_I = V_{IL}$	4.5 V	4.5 V		0.55	
l _l	Control inputs	V _I = V _{CCA} or GND	1.65 V to 5.5 V	1.65 V to 5.5 V	±1	±2	μΑ
	A or B	V V 0 (- 5 5 V	0 V	0 to 5.5 V	±1	±2	^
off	port	V_I or $V_O = 0$ to 5.5 V	0 to 5.5 V	0 V	±1	±2	μΑ
oz	A or B port	$\frac{V_O}{OE} = V_{CCO}$ or GND, $\frac{V_O}{OE} = V_{IH}$	1.65 V to 5.5 V	1.65 V to 5.5 V	±1	±2	μΑ
	- 11		1.65 V to 5.5 V	1.65 V to 5.5 V		20	
I _{CCA}		$V_I = V_{CCI}$ or GND, $I_O = 0$	5 V	0 V		20	μΑ
		10 - 0	0 V	5 V		-2	
			1.65 V to 5.5 V	1.65 V to 5.5 V		20	
І _{ссв}		$V_I = V_{CCI}$ or GND, $I_O = 0$	5 V	0 V		-2	μΑ
		10 - 0	0 V	5 V		20	
I _{CCA} + I ₀	ССВ	$V_I = V_{CCI}$ or GND, $I_O = 0$	1.65 V to 5.5 V	1.65 V to 5.5 V		30	μΑ
	A port	One A port at V _{CCA} – 0.6 V, DIR at V _{CCA} , B port = open				50	
ΔI _{CCA}	DIR	DIR at $V_{CCA} - 0.6 \text{ V}$, B port = open, A port at V_{CCA} or GND	3 V to 5.5 V	3 V to 5.5 V		50	μА
Δl _{CCB}	B port	One B port at V _{CCB} – 0.6 V, DIR at GND, A port = open	3 V to 5.5 V	3 V to 5.5 V		50	μΑ
C _i	Control inputs	V _I = V _{CCA} or GND	3.3 V	3.3 V	4	5	pF
C _{io}	A or B port	$V_O = V_{CCA/B}$ or GND	3.3 V	3.3 V	8.5	10	pF

 $[\]begin{array}{ll} \hbox{(1)} & V_{CCO} \text{ is the } V_{CC} \text{ associated with the output port.} \\ \hbox{(2)} & V_{CCI} \text{ is the } V_{CC} \text{ associated with the input port.} \\ \end{array}$



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Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 1.8 V \pm 0.15 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = ± 0.1	1.8 V 5 V	V _{CCB} = ± 0.2		V _{CCB} = ± 0.3		V _{CCB} = ± 0.5		UNIT
	(INPOT)	(001701)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t _{PLH}	А	В	1.7	21.9	1.3	9.2	1	7.4	0.8	7.1	ns
t _{PHL}	^	В	1.7	21.5	1.5	3.2		7.4	0.0	7.1	113
t _{PLH}	В	А	0.9	23.8	0.8	23.6	0.7	23.4	0.7	23.4	ns
t _{PHL}	Ь	Λ	0.9	25.0	0.0	25.0	0.7	25.4	0.7	25.4	113
t _{PHZ}	ŌĒ	A	1.6	29.6	1.5	29.4	1.5	29.3	1.4	29.2	ns
t _{PLZ}	OL	A	1.0	29.0	1.5	29.4	1.5	29.3	1.4	29.2	115
t _{PHZ}	ŌĒ	В	2.4	32.2	1.9	13.1	1.7	12	1.3	10.3	ns
t _{PLZ}	OL	В	2.4	52.2	1.3	13.1	1.7	12	1.5	10.5	113
t _{PZH}	ŌĒ	Α	0.4	24	0.4	23.8	0.4	23.7	0.4	23.7	ns
t _{PZL}	OL	Α	0.4	24	0.4	23.0	0.4	23.1	0.4	23.1	115
t _{PZH}	ŌĒ	В	1.8	32	1.6	16	1.2	12.6	0.9	10.8	ns
t _{PZL}	OE	В	1.0	32	1.0	10	1.2	12.0	0.9	10.0	115

Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 2.5 V \pm 0.2 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = ± 0.1			= 2.5 V .2 V	V _{CCB} = ± 0.		V _{CCB} 0.5		UNIT
	(INFOT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t _{PLH}	A	В	1.6	21.4	1.2	9	0.8	6.2	0.6	4.8	ns
t _{PHL}	^	Б	1.0	21.4	1.2		0.0	0.2	0.0	4.0	113
t _{PLH}	В	Α	1.2	9.3	1	9.1	1	8.9	0.9	8.8	ns
t _{PHL}	В	A	1.2	9.3		9.1	1	0.9	0.9	0.0	115
t _{PHZ}	ŌĒ	A.	1.4	9	1.4	9	1.4	9	1.4	9	ns
t _{PLZ}	OL	A	1.4	9	1.4	9	1.4	Э	1.4	9	115
t _{PHZ}	ŌĒ	В	2.3	29.6	1.8	11	1.7	9.3	0.9	6.9	ns
t_{PLZ}	OL	В	2.3	29.0	1.0	11	1.7	9.3	0.9	0.9	115
t _{PZH}	ŌĒ	Α	1	10.9	1	10.9	1	10.9	1	10.9	ns
t _{PZL}	OL .	Α	'	10.9		10.9		10.9		10.9	115
t _{PZH}	OE	В	1.7	28.2	1.6	12.9	1.2	9.4	1	6.9	ns
t _{PZL}	OE	В	1.7	20.2	1.0	12.9	1.2	9.4	'	0.9	115

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Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTBUT)	V _{CCB} = ± 0.1		V _{CCB} = ± 0.	2.5 V 2 V	V _{CCB} = ± 0.3		ν _{CCB} ± 0 .		UNIT
	(INPOT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t _{PLH}	А	В	1.5	21.2	1.1	8.8	0.8	6.1	0.5	4.4	ns
t _{PHL}		В	1.0	21.2	1.1	0.0	0.0	0.1	0.5	4.4	113
t _{PLH}	В	А	0.9	7.2	0.8	6.2	0.7	6.1	0.6	6	ns
t _{PHL}		^	0.9	1.2	0.0	0.2	0.7	0.1	0.0	U	113
t _{PHZ}	ŌĒ	A	1.6	8.2	1.6	8.2	1.6	6.2	1.6	8.2	ns
t _{PLZ}	OL	^	1.0	0.2	1.0	0.2	1.0	0.2	1.0	0.2	113
t _{PHZ}	ŌĒ	В	2.1	29	1.7	10.3	1.5	8.6	0.8	6.3	ns
t _{PLZ}	OL	В	2.1	23	1.7	10.5	1.5	0.0	0.0	0.5	113
t _{PZH}	ŌĒ	A	0.8	7.8	0.8	7.8	0.8	7.8	0.8	7.8	ns
t _{PZL}	OL	^	0.0	7.0	0.0	7.0	0.0	7.0	0.0	7.0	113
t _{PZH}	ŌĒ	В	1.6	27.7	1.4	12.4	1.1	8.5	0.9	8.4	ns
t _{PZL}	OL	В	1.0	21.1	1.4	12.4	1.1	0.5	0.9	0.4	115

Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	PARAMETER FROM (INPUT)		V _{CC} = ± 0.1		V _{CC} = ± 0.2		V _{CC} = ± 0.3		ν _{cc} : ± 0.		UNIT
	(INFOT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t _{PLH}	Α	В	1.6	21.4	1	8.8	0.7	6	0.4	4.2	ns
t _{PHL}	Α	В	1.0	21.4		0.0	0.7	O	0.4	4.2	115
t _{PLH}	В	Α	0.7	6.8	0.4	4.8	0.3	4.5	0.3	4.3	ns
t _{PHL}	В	A	0.7	0.0	0.4	4.0	0.5	4.5	0.5	4.5	113
t _{PHZ}	ŌĒ	A	0.3	5.4	0.3	5.4	0.3	5.4	0.3	6.4	ns
t _{PLZ}	OL	A	0.5	5.4	0.5	5.4	0.5	5.4	0.5	0.4	113
t _{PHZ}	ŌĒ	В	2	28.7	1.6	9.7	1.4	8	0.7	5.7	ns
t _{PLZ}	OL	Б		20.1	1.0	3.1	1.4	0	0.7	5.1	113
t _{PZH}	ŌĒ	Α	0.7	5.5	0.7	5.5	0.7	5.5	0.7	5.5	ns
t _{PZL}	OL .	A	0.7	0.0	0.7	0.0	0.7	0.0	0.7	0.0	113
t _{PZH}	ŌĒ	В	1.6	27.6	1.3	11.4	1	8.1	0.9	6	ns
t _{PZL}	OL .	В	1.0	27.0	1.3	11.4	'	0.1	0.9	O	115

Operating Characteristics

 $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	V _{CCA} = V _{CCB} = 1.8 V	V _{CCA} = V _{CCB} = 2.5 V	V _{CCA} = V _{CCB} = 3.3 V	V _{CCA} = V _{CCB} = 5 V	UNIT
C (1)	A-port input, B-port output		2	2	2	3	
C _{pdA} ⁽¹⁾	B-port input, A-port output	$C_L = 0,$	18	19	19	22	
C (1)	A-port input, B-port output	f = 10 MHz, $t_r = t_f = 1 \text{ ns}$	18	19	20	22	pF
C _{pdB} ⁽¹⁾	B-port input, A-port output		2	2	2	2	

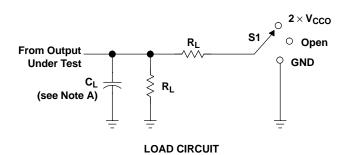
⁽¹⁾ Power dissipation capacitance per transceiver



 V_{CCA}

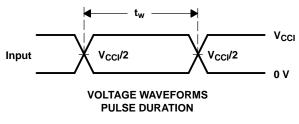
CCA/2

PARAMETER MEASUREMENT INFORMATION

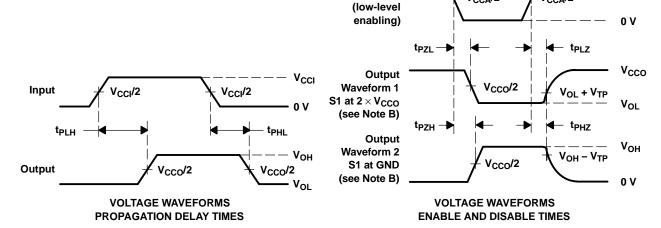


TEST	S1
t _{pd}	Open
t _{PLZ} /t _{PZL}	2×V _{CCO}
t _{PHZ} /t _{PZH}	GND

V _{cco}	CL	R _L	V _{TP}
1.8 V \pm 0.15 V	15 pF	2 k Ω	0.15 V
2.5 V \pm 0.2 V	15 pF	2 k Ω	0.15 V
3.3 V \pm 0.3 V	15 pF	2 k Ω	0.3 V
5 V ± 0.5 V	15 pF	2 k Ω	0.3 V



V_{CCA}/2



Output Control

NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_0 = 50 \Omega$, $dv/dt \geq 1 V/ns$.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en}.
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .
- H. V_{CCI} is the V_{CC} associated with the input port.
- I. V_{CCO} is the V_{CC} associated with the output port.
- J. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGE OPTION ADDENDUM





PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
74LVC16T245DGGRE4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74LVC16T245DGGRG4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74LVC16T245DGVRG4	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74LVC16T245DLRG4	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC16T245DGGR	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC16T245DGVR	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC16T245DGVRG	ACTIVE	TVSOP	DGV	48		TBD	Call TI	Call TI
SN74LVC16T245DL	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC16T245DLG4	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC16T245DLR	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC16T245GQLR	NRND	BGA MI CROSTA R JUNI OR	GQL	56	1000	TBD	SNPB	Level-1-240C-UNLIM
SN74LVC16T245ZQLR	ACTIVE	BGA MI CROSTA R JUNI OR	ZQL	56	1000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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PACKAGE OPTION ADDENDUM

27-Sep-2007

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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION



TAPE DIMENSIONS + K0 - P1 - B0 W Cavity - A0 -

	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LVC16T245DGGR	TSSOP	DGG	48	2000	330.0	24.4	8.6	15.8	1.8	12.0	24.0	Q1
SN74LVC16T245DGVR	TVSOP	DGV	48	2000	330.0	16.4	7.1	10.2	1.6	12.0	16.0	Q1
SN74LVC16T245DLR	SSOP	DL	48	1000	330.0	32.4	11.35	16.2	3.1	16.0	32.0	Q1
SN74LVC16T245GQLR	BGA MI CROSTA R JUNI OR	GQL	56	1000	330.0	16.4	4.8	7.3	1.5	8.0	16.0	Q1
SN74LVC16T245ZQLR	BGA MI CROSTA R JUNI OR	ZQL	56	1000	330.0	16.4	4.8	7.3	1.5	8.0	16.0	Q1

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*All dimensions are nominal

All ullilensions are nominal							
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LVC16T245DGGR	TSSOP	DGG	48	2000	346.0	346.0	41.0
SN74LVC16T245DGVR	TVSOP	DGV	48	2000	346.0	346.0	33.0
SN74LVC16T245DLR	SSOP	DL	48	1000	346.0	346.0	49.0
SN74LVC16T245GQLR	BGA MICROSTAR JUNIOR	GQL	56	1000	333.2	345.9	28.6
SN74LVC16T245ZQLR	BGA MICROSTAR JUNIOR	ZQL	56	1000	333.2	345.9	28.6

GQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-285 variation BA-2.
- D. This package is tin-lead (SnPb). Refer to the 56 ZQL package (drawing 4204437) for lead-free.



ZQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M—1994.

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-285 variation BA-2.
- D. This package is lead-free. Refer to the 56 GQL package (drawing 4200583) for tin-lead (SnPb).



DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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